© Copyr	ial Composition right 2005. IPC, Bann- onal and Pan-America	ockburn, Illinois. A	ll rights reserved u ntions.	nder both	This docume level parts, th	ent is a declar he declaratio	ration o n encor	of the substanc mpasses all lov	es within tl wer level m	ne manufactu aterials for w	rer listed it which the m	em. Not anufacti	te: if the ite urer has er	em is an ass ngineering r	sembly with lowe responsibility.
	IPC Web Site for Information on IPC-1752 Standard     Form Type       http://www.ipc.org/IPC-175x     Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplier Information															
Company name*	Company un	Company unique ID			Unique ID Authority					Respons	Response Date*				
nsemi											2025-06-04				
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email -	Email - Contact*				
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com					
uthorized Representative*	Title - Repres	Title - Representative			Phone - Representative*				Email - Representative*						
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com						
Requester Item Nun	Requester Item Number Mfr Item Num   NV24C64MU G NV24C64MU		a Number Mfr Item Name   54MUW3VTB 64KB I2C SER EEPROM UDFN WETTABLE FLANKS			Effective Da	fective Date Version Manufacturing S		uring Site	7	Weight*	U	JOM	Unit Type	
						2025-06-04 TH6			9.28		n	ng	Each		
Manufacturing Proccess	Information														
Terminal Plating / Gr	l Plating / Grid Array Material Termi		Base Alloy J-STD-020 MS		L Rating	Peak Proc		ess Body Temperature Max Time at Peal		Temperature Numbe		umber of F	Reflow Cycl	les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy	CU Alloy 1			260		С	30		secon	ds 3			
Comments															
evel 1 - maximum time at peal	k temperature durin	g soldering is 10-3	0 seconds												
or more information regardi	ng material composit	ion please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.116	mg	Supplier	Silicon (Si)	7440-21-3		0.116	mg
Die Attach	0.055	mg	Supplier	Silver (Ag)	7440-22-4		0.0468	mg
			Supplier	Acrylic resins	Proprietary Data		0.0082	mg
Lead Frame	2.96	mg	Supplier	Tin (Sn)	7440-31-5		0.0074	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0065	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0074	mg
			Supplier	Copper (Cu)	7440-50-8		2.9387	mg
Mold Compound-Black	5.725	mg		Epoxy resin	proprietary data		0.2862	mg
			Supplier	Phenolic Resin	Proprietary Data		0.1317	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.2862	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0229	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1317	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		4.8663	mg
Plating	0.057	mg	Supplier	Palladium (Pd)	7440-05-3		0.0035	mg
			В	Nickel (Ni)	7440-02-0		0.0528	mg
			Supplier	Gold (Au)	7440-57-5		0.0006	mg
Plating-Sn	0.307	mg	Supplier	Tin (Sn)	7440-31-5		0.307	mg
Wire Bond - Au	0.06	mg	Supplier	Gold (Au)	7440-57-5		0.06	mg